

4 Board Layout

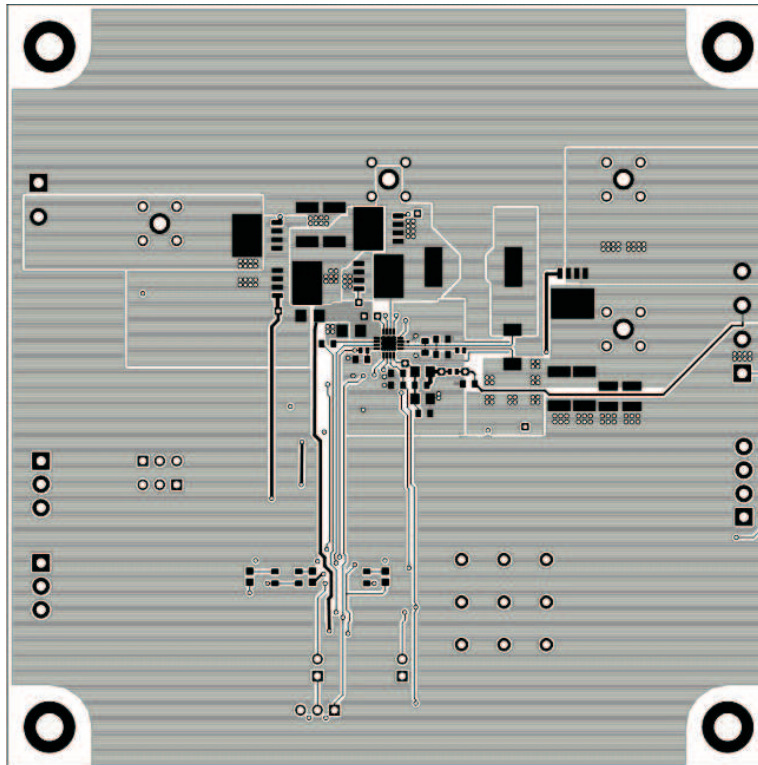


Figure 2. Top Layer

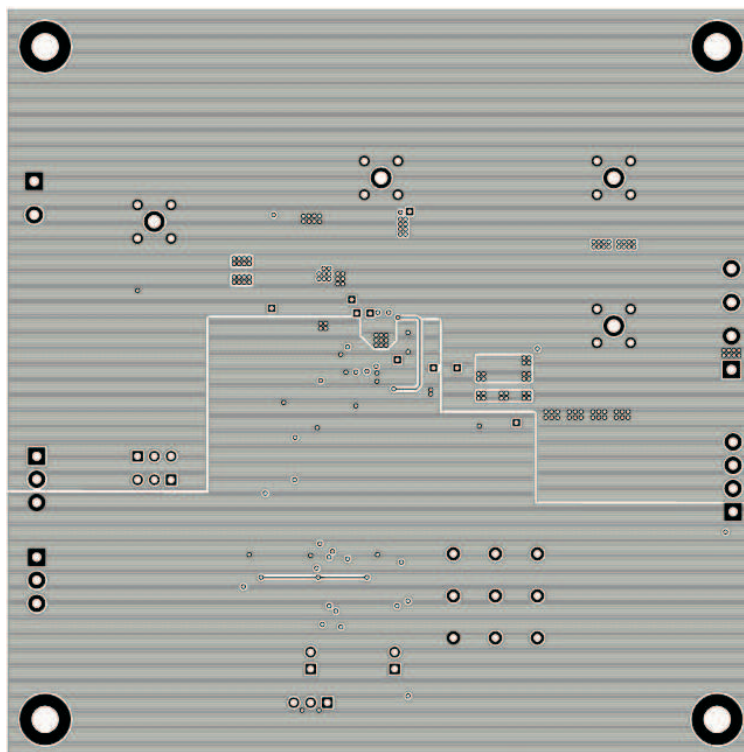


Figure 3. 2nd Layer

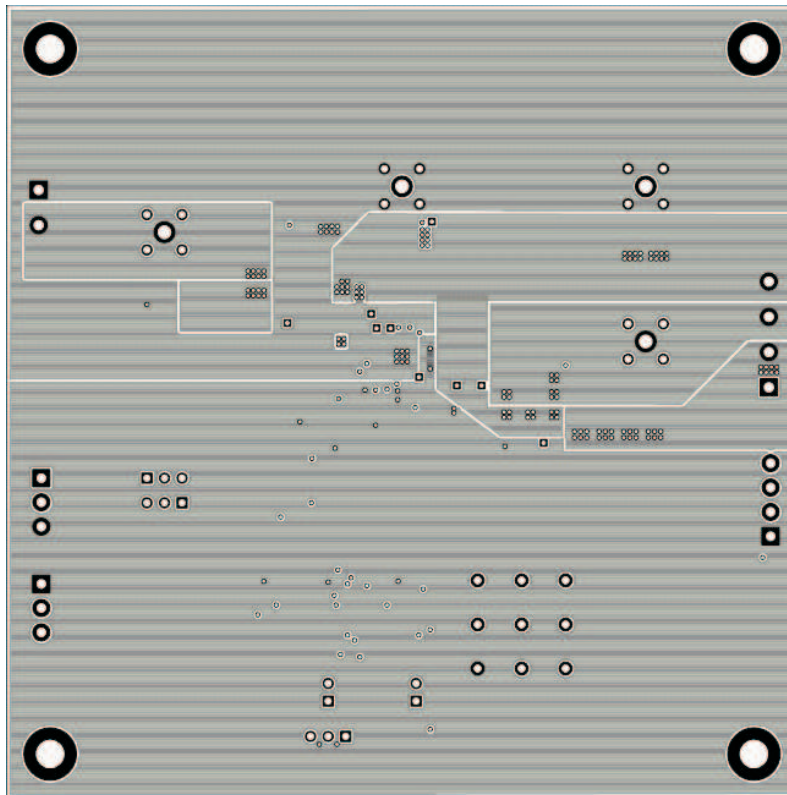


Figure 4. 3rd Layer

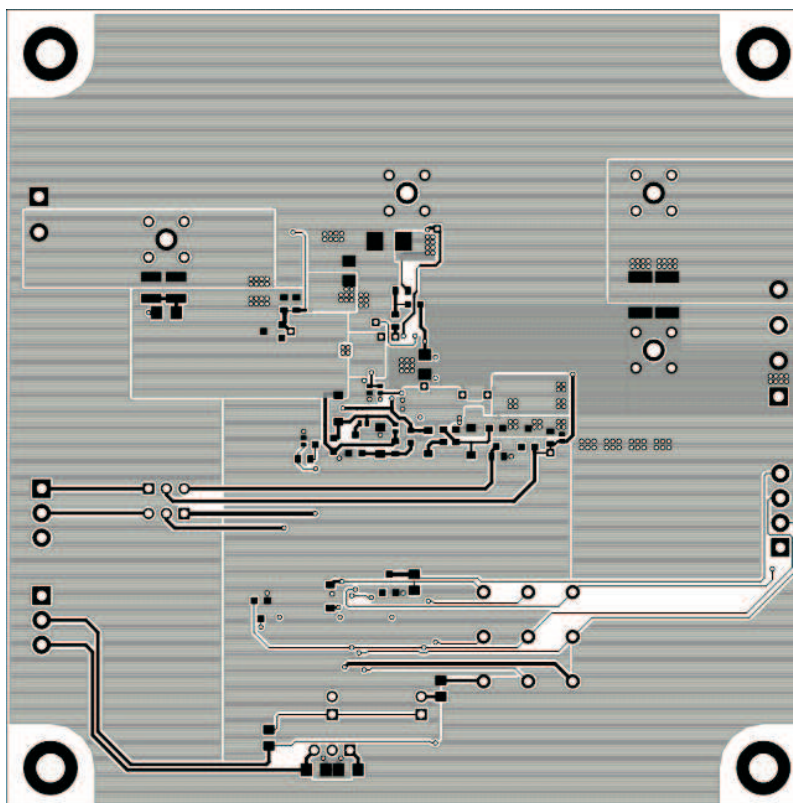


Figure 5. Bottom Layer

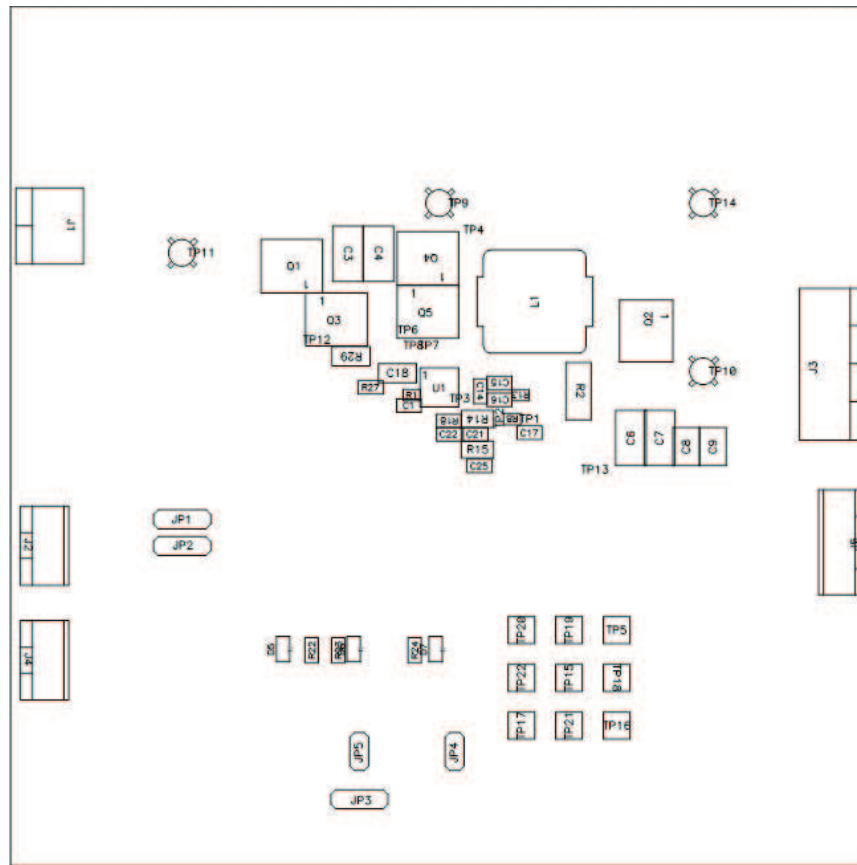


Figure 6. Top Assembly

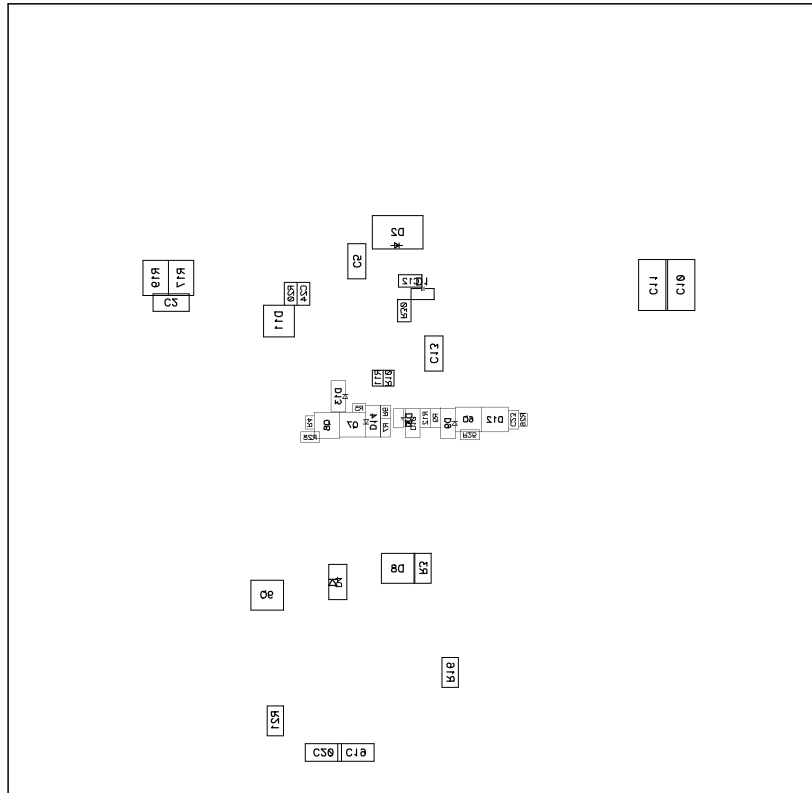


Figure 7. Bottom Assembly

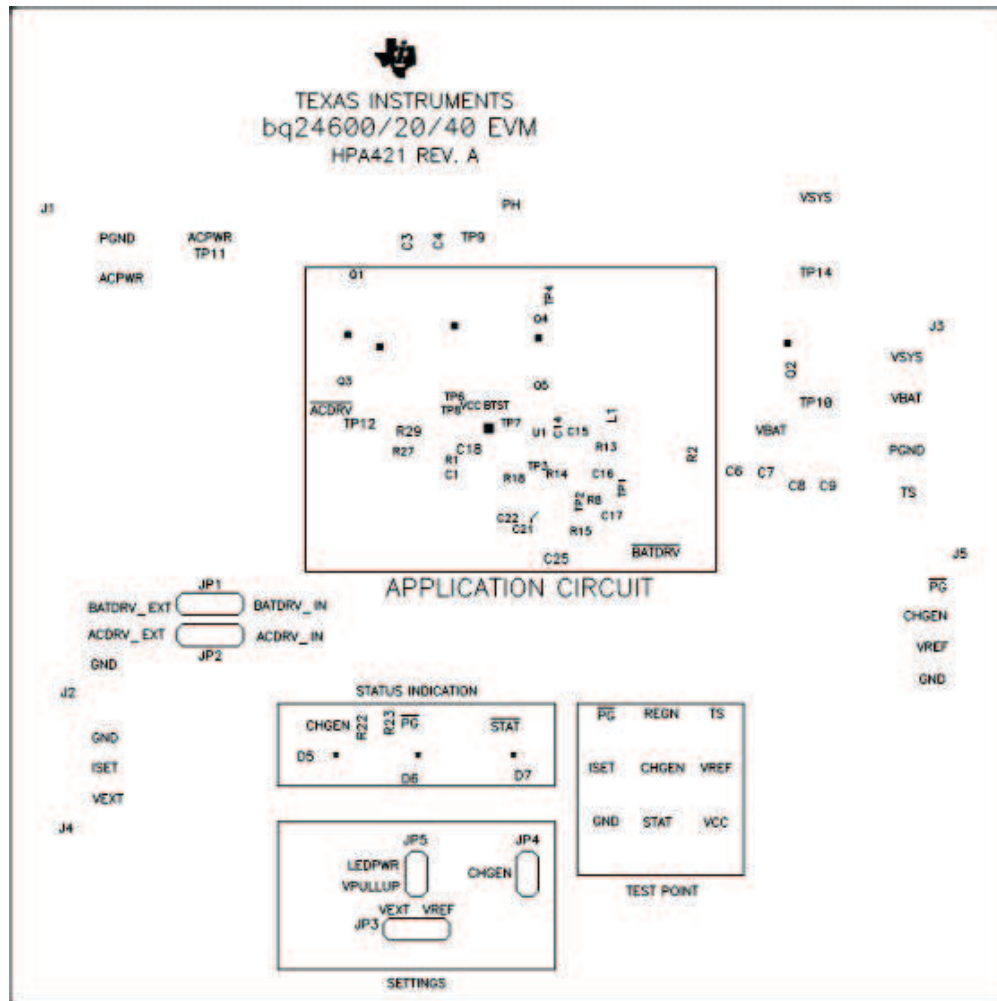


Figure 8. Top Silkscreen

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